

< C band internally matched power GaAs FET >

MGFC36V4450A

4.4 - 5.0 GHz BAND / 4W

DESCRIPTION

The MGFC36V4450A is an internally impedance-matched GaAs power FET especially designed for use in 4.4 – 5.0 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

Class A operation

Internally matched to 50(ohm) system

• High output power

P1dB=4W (TYP.) @f=4.4 - 5.0GHz

• High power gain

GLP=12dB (TYP.) @f=4.4 - 5.0GHz

High power added efficiency

P.A.E.=32% (TYP.) @f=4.4 - 5.0GHz

• Low distortion [item -51]

IM3=-45dBc (TYP.) @Po=25dBm S.C.L

APPLICATION

• item 01: 4.4 – 5.0 GHz band power amplifier

• item 51: 4.4 – 5.0 GHz band digital radio communication

QUALITY

• IG

RECOMMENDED BIAS CONDITIONS

• VDS=10V • ID=1.2A Refer to Bias Procedure • RG=100ohm

Absolute maximum ratings (Ta=25°C)

Parameter	Ratings	Unit	
Gate to drain breakdown voltage	-15	V	
Gate to source breakdown voltage	-15	V	
Drain current	3.75	Α	
Reverse gate current	-10	mA	
Forward gate current	21	mA	
Total power dissipation	25	W	
Cannel temperature	175	°C	
Storage temperature	-65 to +175	°C	
	Gate to drain breakdown voltage Gate to source breakdown voltage Drain current Reverse gate current Forward gate current Total power dissipation Cannel temperature	Gate to drain breakdown voltage -15 Gate to source breakdown voltage -15 Drain current 3.75 Reverse gate current -10 Forward gate current 21 Total power dissipation 25 Cannel temperature 175 Storage temperature -65 to +175	

1 : Tc=25°C

OUTLINE DRAWING Unit: millimeters 21.0 +/-0.3 12.9 +/-0.2 (3) GATE SOURCE (FLANGE) DRAIN GF-8

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Electrical characteristics

Symbol	Parameter	Test conditions	Limits		Unit	
			Min.	Тур.	Max.	
IDSS	Saturated drain current	VDS=3V,VGS=0V	-	=	3.75	Α
gm	Transconductance	VDS=3V,ID=1.1A	-	1	-	S
VGS(off)	Gate to source cut-off voltage	VDS=3V,ID=10mA	-	-	-4.5	V
P1dB	Output power at 1dB gain compression	VDS=10V,ID(RF off)=1.2A	35	37	-	dBm
GLP	Linear Power Gain	f=4.4 – 5.0GHz	11	12	-	dB
ID	Drain current		-	-	1.8	Α
P.A.E.	Power added efficiency		-	32	-	%
IM3 *2	3rd order IM distortion		-42	-45	-	dBc
Rth(ch-c) *3	Thermal resistance	delta Vf method	-	5	6	°C/W

^{*2 :}item -51 ,2 tone test,Po=25dBm Single Carrier Level ,f=5.0GHz,delta f=10MHz

^{*3 :}Channel-case

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